# 74HC4020-Q100; 74HCT4020-Q100

# 14-stage binary ripple counter

Rev. 2 — 18 June 2020

Product data sheet

### 1. General description

The 74HC4020-Q100; 74HCT4020-Q100 is a 14-stage binary ripple counter with a clock input  $(\overline{CP})$ , an overriding asynchronous master reset input (MR) and 12 buffered parallel outputs (Q0, and Q3 to Q13). The counter advances on the HIGH-to-LOW transition of  $\overline{CP}$ . A HIGH on MR clears all counter stages and forces all outputs LOW, independent of the state of  $\overline{CP}$ . Each counter stage is a static toggle flip-flop. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- · Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- · CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC4020-Q100: CMOS level
  - For 74HCT4020-Q100: TTL level
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0  $\Omega$ )
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

# 3. Applications

- · Frequency dividing circuits
- Time delay circuits
- Control counters

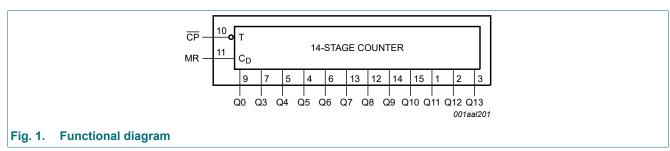


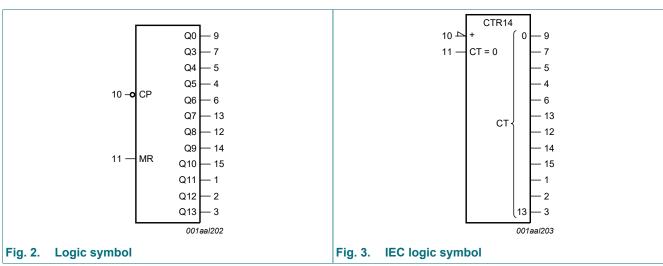
# 4. Ordering information

**Table 1. Ordering information** 

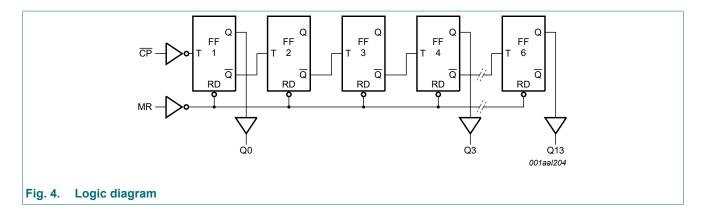
Type number	Package									
	Temperature range	Name	Description	Version						
74HC4020D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1						
74HCT4020D-Q100			body width 3.9 mm							
74HC4020PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1						
74HCT4020PW-Q100			body width 4.4 mm							
74HC4020BQ-Q100	-40 °C to +125 °C	DHVQFN16								
74HCT4020BQ-Q100			very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm							

# 5. Functional diagram



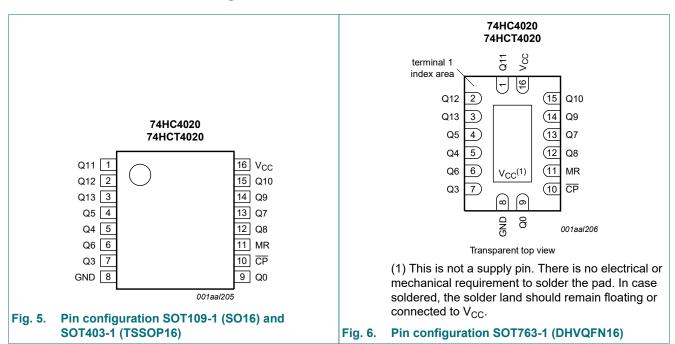


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# 6. Pinning information

### 6.1. Pinning



### 6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
Q0, Q3 to Q13	9, 7, 5, 4, 6, 13, 12, 14, 15, 1, 2, 3	output
GND	8	ground (0 V)
CP	10	clock input (HIGH-to-LOW, edge-triggered)
MR	11	master reset input (active HIGH)
V <sub>CC</sub>	16	positive supply voltage

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## 7. Functional description

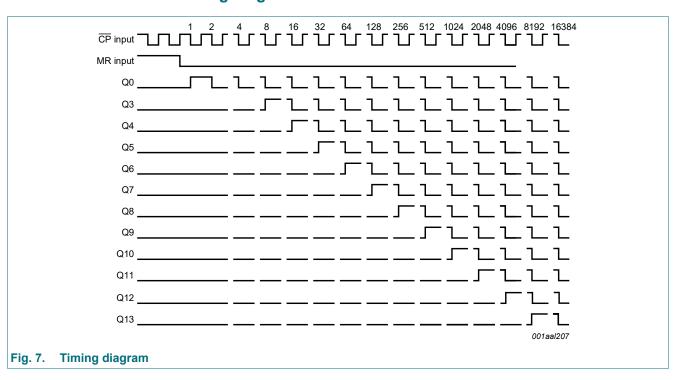
#### **Table 3. Function table**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care;$ 

 $\uparrow$  = LOW-to-HIGH clock transition;  $\downarrow$  = HIGH-to-LOW clock transition.

Input	Output	
СР	MR	Q0, Q3 to Q13
<b>↑</b>	L	no change
<b>\</b>	L	count
X	Н	L

### 7.1. Timing diagram



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# 8. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I <sub>CC</sub>	supply current			-	±50	mA
I <sub>GND</sub>	ground current			-	±50	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[1]	-	500	mW

<sup>[1]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P<sub>tot</sub> derates linearly with 11.2 mW/K above 106 °C.

# 9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	74H	C4020-0	Q100	74H0	CT4020-	Q100	Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Δt/ΔV	input transition rise	except for Schmitt trigger inputs							
	and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C

# 10. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	20-Q100									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_O = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT4	020-Q100						'			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>O</sub> = -20 μΑ	4.4	4.5	-	4.4	-	4.4	-	V
	I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V	
V <sub>OL</sub> LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$									
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	-	80	-	160	μΑ
ΔI <sub>CC</sub> additional supply current		$V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		pin MR	-	110	396	-	495	-	539	μΑ
		pin CP	-	85	306	-	383	-	417	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

# 11. Dynamic characteristics

### **Table 7. Dynamic characteristics**

GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit, see Fig. 10

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC402	20-Q100									
t <sub>pd</sub>	propagation	CP to Q0; see Fig. 8 [1]								
	delay	V <sub>CC</sub> = 2.0 V	-	39	140	-	175	-	210	ns
		V <sub>CC</sub> = 4.5 V	-	14	28	-	35	-	42	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	11	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	11	24	-	30	-	36	ns
		Qn to Qn+1; see Fig. 9								
		V <sub>CC</sub> = 2.0 V	-	22	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	8	15	-	19	-	22	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	6	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Fig. 8								
	propagation delay	V <sub>CC</sub> = 2.0 V	-	55	170	-	215	-	225	ns
	uelay	V <sub>CC</sub> = 4.5 V	-	20	34	-	43	-	51	ns
		$V_{CC}$ = 5.0 V; $C_L$ = 15 pF	-	17	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	16	29	-	37	-	43	ns

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>t</sub>	transition time	Qn; see Fig. 8 [2]								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	80	14	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	4	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	3	-	17	-	20	-	ns
		MR HIGH; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	17	-	20	-	ns
t <sub>rec</sub>	recovery time	MR to CP; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	50	6	-	65	-	75	-	ns
		V <sub>CC</sub> = 4.5 V	10	2	-	13	-	15	-	ns
		V <sub>CC</sub> = 6.0 V	9	2	-	11	-	13	-	ns
f <sub>max</sub>	maximum	see Fig. 8								
	frequency	V <sub>CC</sub> = 2.0 V	6.0	30	-	4.8	-	4.0	-	MHz
		V <sub>CC</sub> = 4.5 V	30	92	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	101	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	35	109	-	28	-	24	-	MHz
C <sub>PD</sub>	power dissipation capacitance	[3]	-	19	-	-	-	-	-	pF
74HCT4	020-Q100									
t <sub>pd</sub>	propagation	CP to Q0; see Fig. 8 [1]								
-рu	delay	V <sub>CC</sub> = 4.5 V	_	18	36	_	45	_	54	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	_	15	-	_	-	-	-	ns
		Qn to Qn+1; see Fig. 9								1
		V <sub>CC</sub> = 4.5 V	_	8	15	_	19	_	22	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	_	6	-	_	-	_	-	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Fig. 8								110
PHL	propagation	V <sub>CC</sub> = 4.5 V	_	22	45	-	56	-	68	ns
	delay	$V_{CC} = 5.0 \text{ V}; C_{L} = 15 \text{ pF}$	_	19	-	_	-	_	-	ns
t <sub>t</sub>	transition time			.0						-
ન		V <sub>CC</sub> = 4.5 V	_	7	15	_	19	-	22	ns
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 8		,						+
-v v	12 S. 23 MAGI	V <sub>CC</sub> = 4.5 V	20	7	_	25	-	30	_	ns
		MR HIGH; see Fig. 8		,						+
		V <sub>CC</sub> = 4.5 V	20	8	_	25	-	30	_	ns
t <sub>rec</sub>	recovery time	MR to $\overline{CP}$ ; see Fig. 8	20					- 55		+
1.ec	. 300 vol y tilllo	V <sub>CC</sub> = 4.5 V	10	2	_	13	-	15	_	ns
		v (( = <del>+</del> .∪ v	10			10	_	10		113

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
				Min	Тур	Max	Min	Max	Min	Max	
f <sub>max</sub>	maximum frequency	see Fig. 8									
		V <sub>CC</sub> = 4.5 V		25	47	-	20	-	17	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	52	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance		[3]	-	20	-	-	-	-	-	pF

- $t_{\text{pd}}$  is the same as  $t_{\text{PHL}}$  and  $t_{\text{PLH}}.$ [1]
- $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

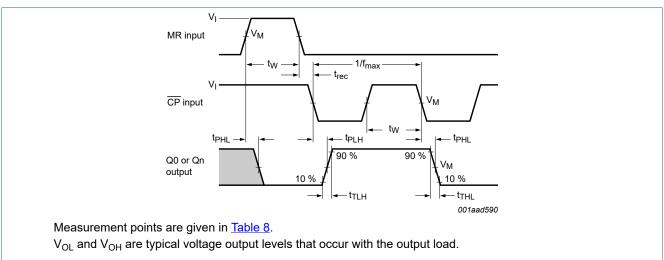
f<sub>o</sub> = output frequency in MHz;

 $\Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs};$ 

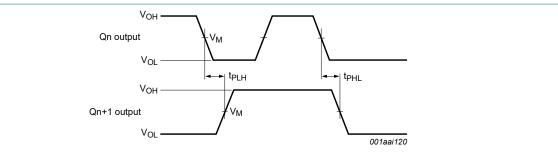
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V.

#### 11.1. Waveforms and test circuit



Clock timing, propagation delays and pulse widths Fig. 8.



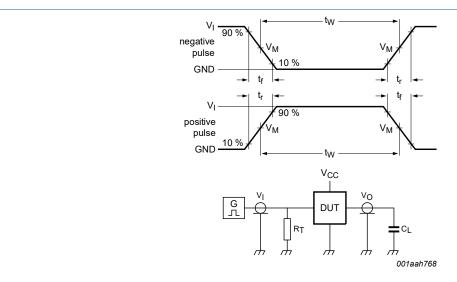
Measurement points are given in Table 8.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 9. Waveforms showing the output Qn to output Qn+1 propagation delays

**Table 8. Measurement points** 

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC4020-Q100	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>
74HCT4020-Q100	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

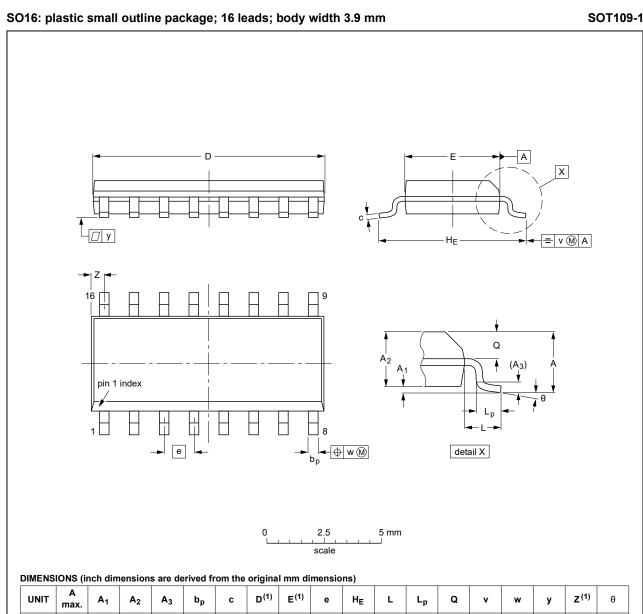
Fig. 10. Test circuit for measuring switching times

Table 9. Test data

Туре	Input	Load	
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>
74HC4020-Q100	V <sub>CC</sub>	6 ns	15 pF, 50 pF
74HCT4020-Q100	3 V	6 ns	15 pF, 50 pF

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# 12. Package outline



	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
i	nches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

#### Note

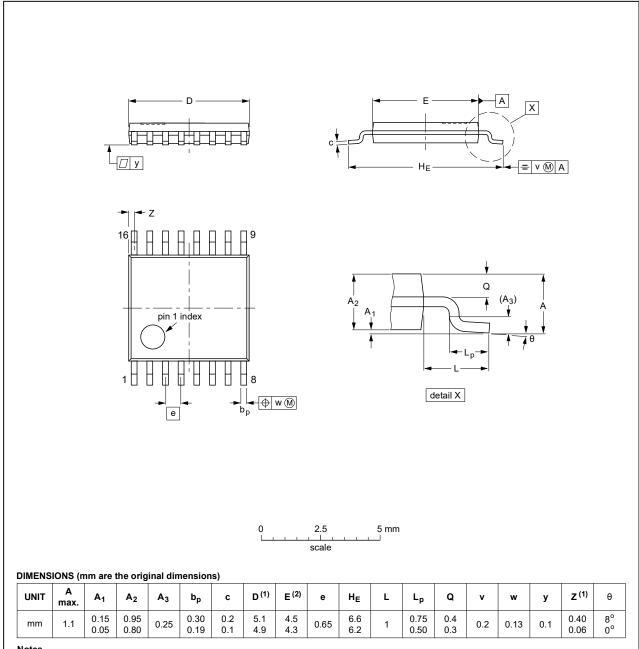
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig. 11. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 12. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

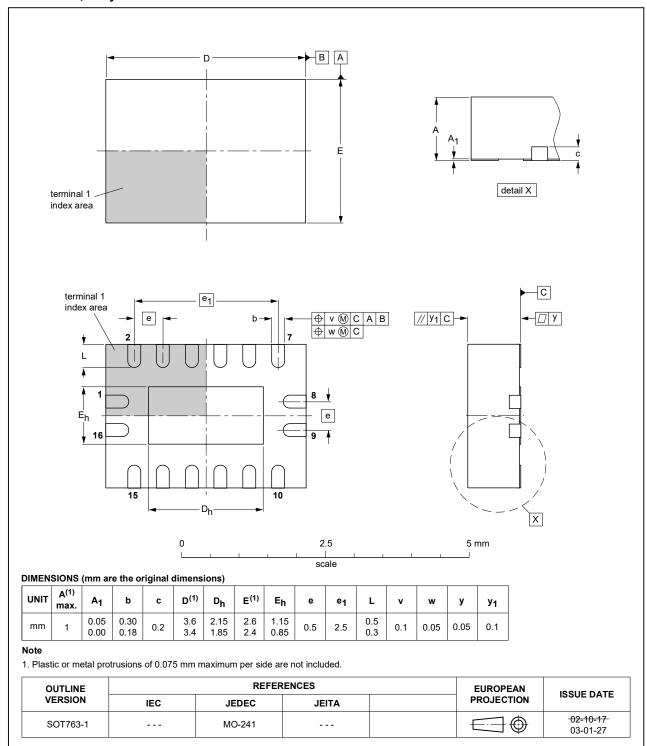


Fig. 13. Package outline SOT763-1 (DHVQFN16)

**Product data sheet** 

# 13. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4020_Q100 v.2	20200618	Product data sheet	-	74HC_HCT4020_Q100 v.1
Modifications:	of Nexperia.  • Legal texts have • Section 1 and S	nis data sheet has been in the new section 2 updated.  The values for Ptot total points and the section 2 updated.	ew company name v	
74HC_HCT4020_Q100 v.1	20130523	Product data sheet	-	-

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

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